

DIM1200FSS17-A000

Single Switch IGBT Module

DS6366-1 September 2021 (LN41131)

FEATURES

- 10µs Short Circuit Withstand
- High Thermal Cycling Capability
- Non Punch Through Silicon
- Isolated Cu Base with Al₂O₃ Substrates
- Lead Free construction

APPLICATIONS

- High Reliability Inverters
- Motor Controllers
- Traction Drives

The Powerline range of high power modules includes half bridge, chopper, dual, single and bi-directional switch configurations covering voltages from 1200V to 6500V and currents up to 2400A.

The DIM1200FSS17-A000 is a single switch 1700V, n-channel enhancement mode, insulated gate bipolar transistor (IGBT) module. The IGBT has a wide reverse bias safe operating area (RBSOA) plus 10µs short circuit withstand. This device is optimised for traction drives and other applications requiring high thermal cycling capability.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

ORDERING INFORMATION

Order As:

DIM1200FSS17-A000

Note: When ordering, please use the complete part number

Caution: This device is sensitive to electrostatic discharge. Users should follow ESD handling procedures

KEY PARAMETERS

V_{CES}		1700V
V _{CE(sat)}	* (typ)	2.7V
Ic	(max)	1200A
I _{C(PK)}	(max)	2400A

^{*} Measured at the power busbars, not the auxiliary terminals

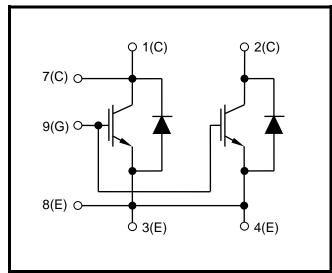


Fig. 1 Circuit configuration

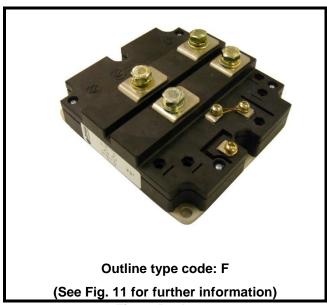


Fig. 2 Package

ABSOLUTE MAXIMUM RATINGS

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Vces	Collector-emitter voltage	VgE = 0V	1700	V
V _{GES}	Gate-emitter voltage		±20	V
lc	Continuous collector current	T _{case} = 75°C	1200	Α
I _{C(PK)}	Peak collector current	1ms, T _{case} = 105°C	2400	Α
P _{max}	Max. transistor power dissipation	$T_{case} = 25^{\circ}C, T_j = 150^{\circ}C$	10400	W
l²t	Diode I ² t value	$V_R = 0$, $t_p = 10$ ms, $T_j = 125$ °C	480	kA ² s
Visol	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	4000	V
Q_{PD}	Partial discharge – per module	IEC1287, V ₁ = 1800V, V ₂ = 1300V, 50Hz RMS	10	рС

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
R _{th(j-c)}	Thermal resistance – transistor	Continuous dissipation - junction to case	-	-	14	°C/kW
R _{th(j-c)}	Thermal resistance – diode	Continuous dissipation - junction to case	-	-	22	°C/kW
R _{th(c-h)}	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)	-	-	8	°C/kW
Tj	Junction temperature	Transistor	-	-	150	°C
		Diode	_	-	125	°C
T _{stg}	Storage temperature range	-	-40	-	125	°C
	Screw torque	Mounting – M6	-	-	5	Nm
		Electrical connections – M4	-	-	2	Nm
		Electrical connections – M8	-	-	10	Nm

ELECTRICAL CHARACTERISTICS

 T_{case} = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
I _{CES}	Collector cut-off current	V _{GE} = 0V, V _{CE} = V _{CES}			2	mA
		V _{GE} = 0V, V _{CE} = V _{CES} , T _{case} = 125°C			50	mA
I _{GES}	Gate leakage current	V _{GE} = ± 20V, V _{CE} = 0V			6	μA
V _{GE(TH)}	Gate threshold voltage	Ic = 60mA, V _{GE} = V _{CE}	4.5	5.5	6.5	V
\/ +	Collector-emitter	V _{GE} = 15V, I _C = 1200A		2.7	3.2	V
V _{CE(sat)} †	saturation voltage	V _{GE} = 15V, I _C = 1200A, T _j = 125°C		3.4	4.0	V
l _F	Diode forward current	DC			1200	Α
I _{FM}	Diode maximum forward current	$t_p = 1 ms$			2400	Α
\/ +	Diode forward voltage	I _F = 1200A		2.0	2.3	V
V _F †		I _F = 1200A, T _j = 125°C		2.0	2.3	V
Cies	Input capacitance	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz		90		nF
Qg	Gate charge	±15V		14		μC
Cres	Reverse transfer capacitance	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz				nF
L _M	Module inductance			15		nH
R _{INT}	Internal transistor resistance			270		μΩ
SC _{Data}	Short circuit current, Isc	$T_{j} = 125^{\circ}C$, $V_{CC} = 1000V$ $t_{p} \le 10\mu s$, $V_{GE} \le 15V$ $V_{CE (max)} = V_{CES} - L^{*} x dI/dt$ IEC 60747-9		4800		А

 $^{^{\}dagger}\,$ Measured at the power busbars, not the auxiliary terminals $^{\star}\,$ L is the circuit inductance + L_{M}

ELECTRICAL CHARACTERISTICS

 T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
t _{d(off)}	Turn-off delay time			1350		ns
tf	Fall time	$I_C = 1200A$ $V_{GE} = \pm 15V$		200		ns
Eoff	Turn-off energy loss	$V_{CE} = £15V$ $V_{CE} = 900V$		350		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 1.8\Omega$		300		ns
tr	Rise time	$R_{G(OFF)} = 1.8\Omega$ Ls ~ 100nH		250		ns
Eon	Turn-on energy loss	23 / 1001111		280		mJ
Qrr	Diode reverse recovery charge	I _F = 1200A		400		μC
Irr	Diode reverse recovery current	V _{CE} = 900V		850		Α
Erec	Diode reverse recovery energy	dI _F /dt = 6000A/μs		200		mJ

T_{case} = 125°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
t _{d(off)}	Turn-off delay time	I _C = 1200A V _{GE} = ±15V		1550		ns
t _f	Fall time			250		ns
Eoff	Turn-off energy loss	$V_{CE} = 900V$		550		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 1.8\Omega$ $R_{G(OFF)} = 1.8\Omega$ $L_{S} \sim 100 nH$		400		ns
t _r	Rise time			250		ns
E _{ON}	Turn-on energy loss			450		mJ
Qrr	Diode reverse recovery charge	I _F = 1200A V _{CE} = 900V		600		μC
Irr	Diode reverse recovery current			950		Α
Erec	Diode reverse recovery energy	dl _F /dt = 5500A/μs		400		mJ

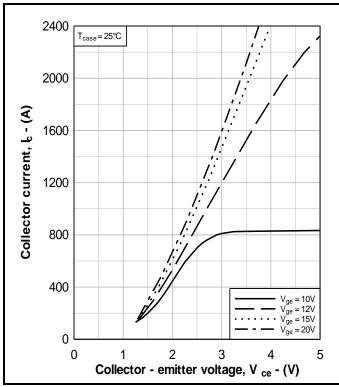


Fig. 3 Typical output characteristics

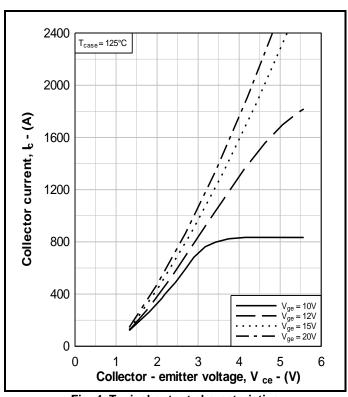


Fig. 4 Typical output characteristics

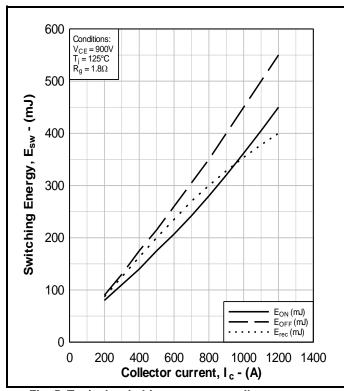


Fig. 5 Typical switching energy vs collector current

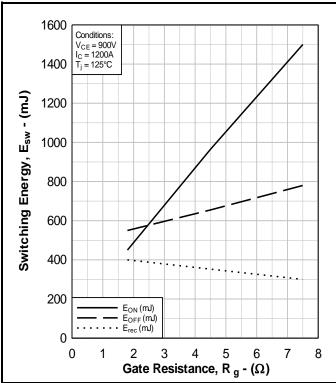


Fig. 6 Typical switching energy vs gate resistance

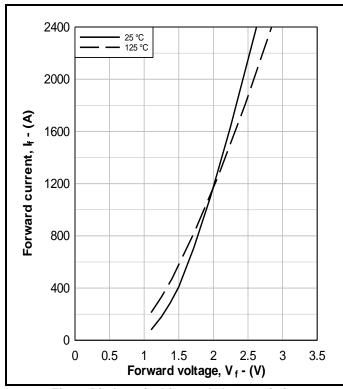


Fig. 7 Diode typical forward characteristics

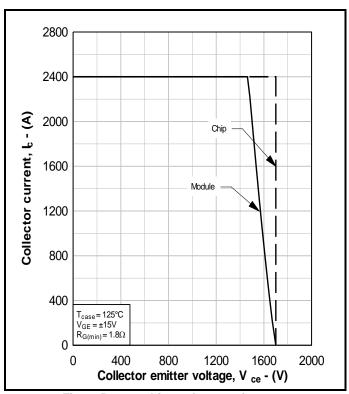


Fig. 8 Reverse bias safe operating area

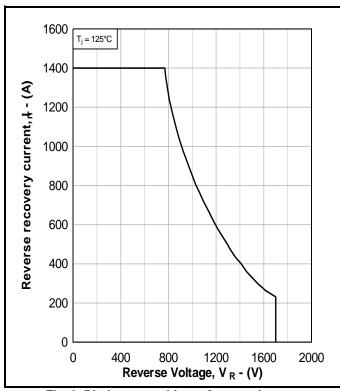


Fig. 9 Diode reverse bias safe operating area

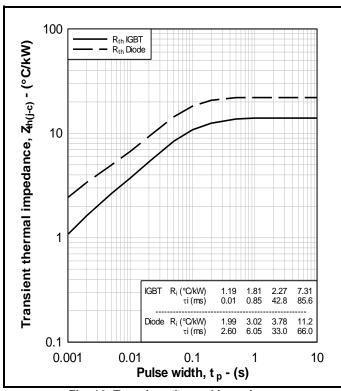


Fig. 10 Transient thermal impedance

PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise.

DO NOT SCALE.

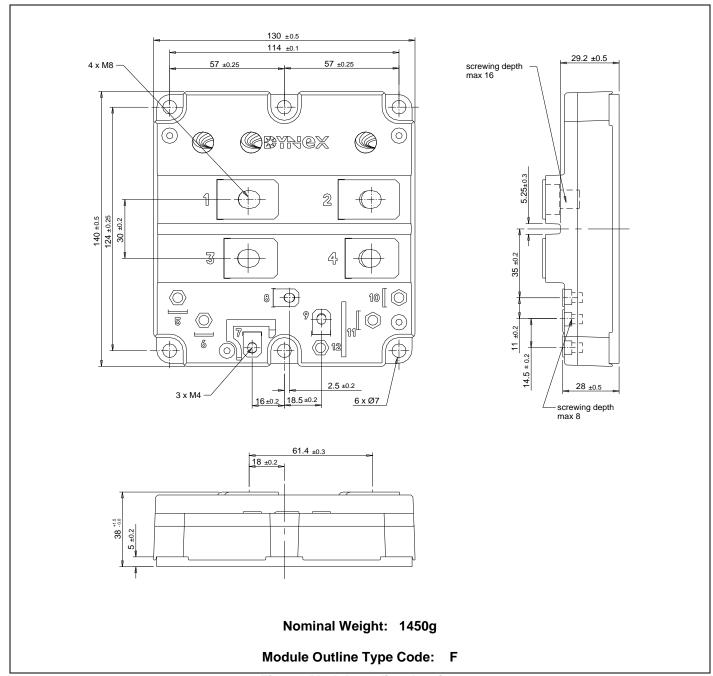


Fig. 11 Module outline drawing

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Extended exposure to conditions outside the product ratings may affect reliability leading to premature product failure. Use outside the product ratings is likely to cause permanent damage to the product. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture, a large current to flow or high voltage arcing, resulting in fire or explosion. Appropriate application design and safety precautions should always be followed to protect persons and property.

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